

## Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating		Unit
			TLP525G	TLP525G-2 TLP525G-4	
LED	Forward current	I <sub>F</sub>	50	50	mA
	Forward current derating	I <sub>F</sub> / °C	-0.7 (Ta ≥ 53°C)	-0.5 (Ta ≥ 25°C)	mA / °C
	Pulse forward current	I <sub>FP</sub>	1 (100μs pulse, 100pps)		A
	Reverse voltage	V <sub>R</sub>	5		V
	Input power dissipation	P <sub>D</sub>	50	60	mW
	Input power dissipation derating	ΔP <sub>D</sub> / °C	-0.69 (Ta ≥ 53°C)	-0.6 (Ta ≥ 25°C)	mW / °C
	Junction temperature	T <sub>j</sub>	125		°C
Detector	Off-state output terminal voltage	V <sub>DRM</sub>	400		V
	On-state RMS current	I <sub>T</sub> (RMS)	100	80	mA
			50	40	
	On-state current derating (Ta ≥ 25°C)	I <sub>T</sub> / °C	-1.1	-0.9	mA / °C
	Peak on state current	I <sub>TP</sub>	2 (100μs pulse, 120pps)		A
	Peak non-repetitive surge current (P <sub>W</sub> = 10ms)	I <sub>TSM</sub>	1.2		A
	Output power dissipation	P <sub>O</sub>	300	240	mW
	Output power dissipation derating (Ta ≥ 25°C)	ΔP <sub>O</sub> / °C	-3.0	-2.4	mW / °C
	Junction temperature	T <sub>j</sub>	115		°C
Storage temperature range		T <sub>stg</sub>	-55 to 125		°C
Operating temperature range		T <sub>opr</sub>	-40 to 100		°C
Lead soldering temperature		T <sub>sol</sub>	260 (10 s)		°C
Isolation voltage (Note)		BVS	2500 (AC, 60 s, R.H. ≤ 60 %)		V <sub>rms</sub>

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note: Device considered a two terminal device: LED side pins shorted together and detector side pins shorted together.

## Recommended Operating Conditions

Characteristic	Symbol	Min	Typ.	Max	Unit
Supply voltage	V <sub>AC</sub>	—	—	120	V <sub>ac</sub>
Forward current	I <sub>F</sub>	15	20	25	mA
Peak on-state current	I <sub>TP</sub>	—	—	1	A
Operating temperature	T <sub>opr</sub>	-25	—	85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

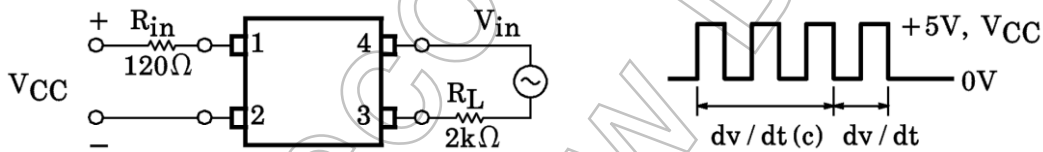
Individual Electrical Characteristics (Ta = 25°C)

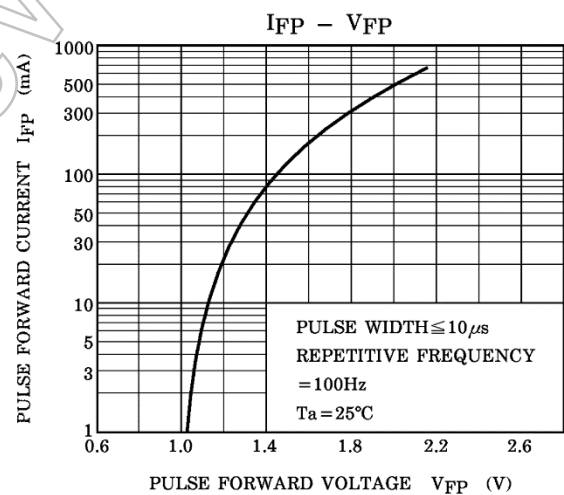
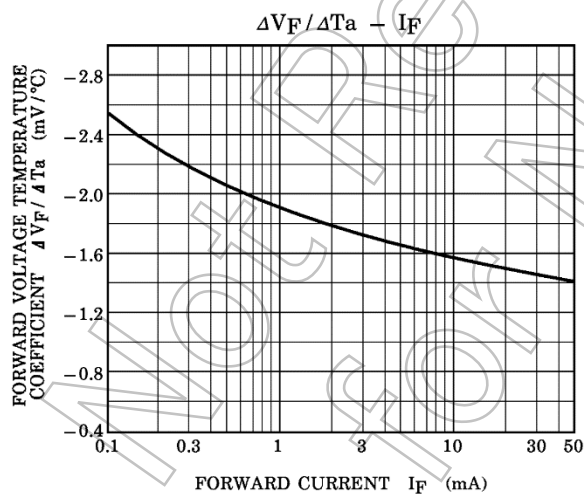
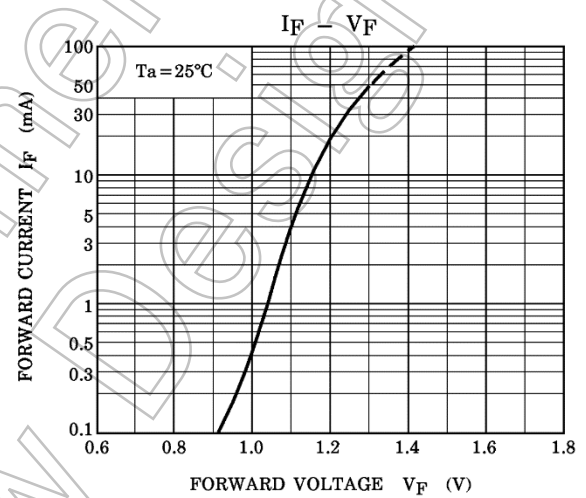
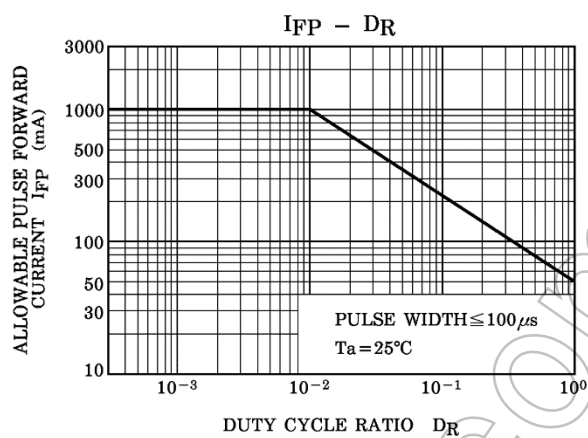
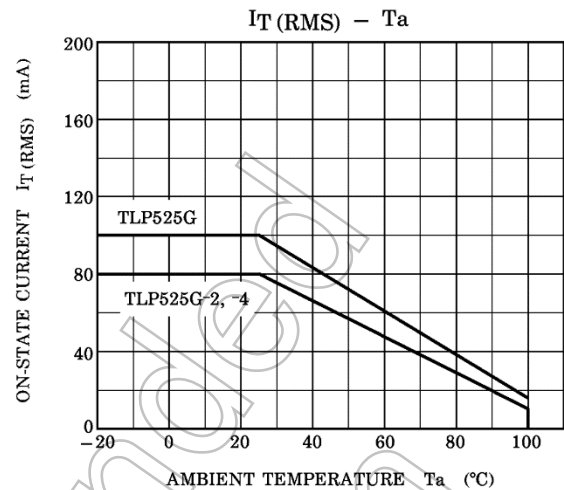
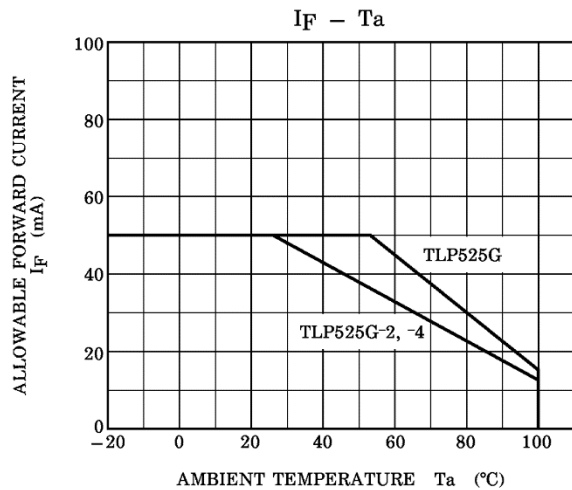
Characteristic		Symbol	Test Condition	Min	Typ.	Max	Unit
LED	Forward voltage	$V_F$	$I_F = 10\text{ mA}$	1.0	1.15	1.3	V
	Reverse current	$I_R$	$V_R = 5\text{ V}$	—	—	10	$\mu\text{A}$
	Capacitance	$C_T$	$V_F = 0\text{ V}, f = 1\text{ MHz}$	—	30	—	pF
Detector	Peak off-state current	$I_{DRM}$	$V_{DRM} = 400\text{ V}$	—	10	100	nA
	Peak on-state voltage	$V_{TM}$	$I_{TM} = 100\text{ mA}$	—	1.7	3.0	V
	Holding current	$I_H$	—	—	0.6	—	mA
	Critical rate of rise of off-state voltage	$dv/dt$	$V_{in} = 120\text{ V}_{rms}, T_a = 85\text{ }^\circ\text{C}$ (Figure 1)	200	500	—	V / $\mu\text{s}$
	Critical rate of rise of commutating voltage	$dv/dt(c)$	$V_{in} = 30\text{ V}_{rms}, I_T = 15\text{ mA}$ (Figure 1)	—	0.2	—	V / $\mu\text{s}$

Coupled Electrical Characteristics (Ta = 25°C)

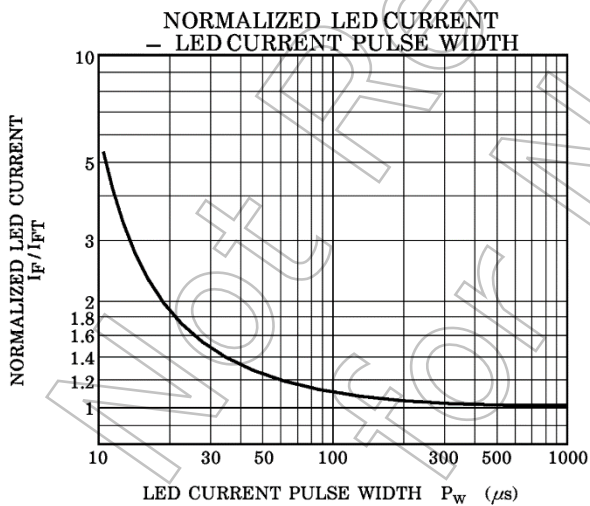
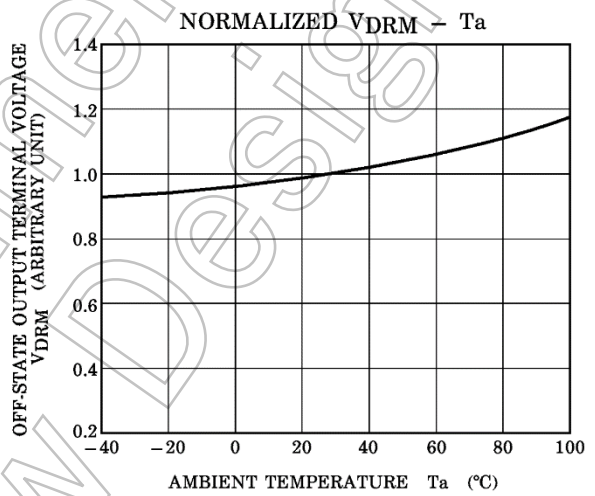
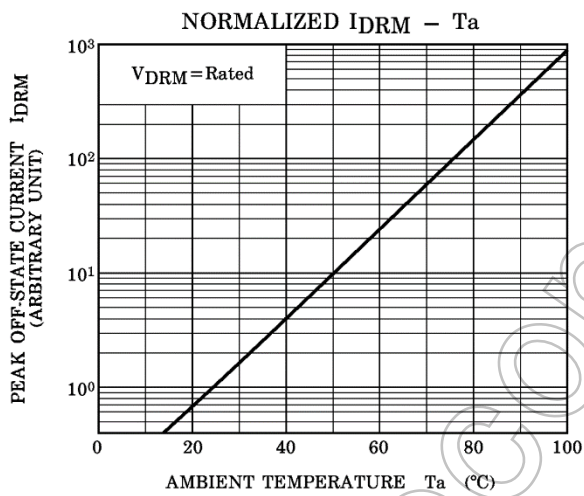
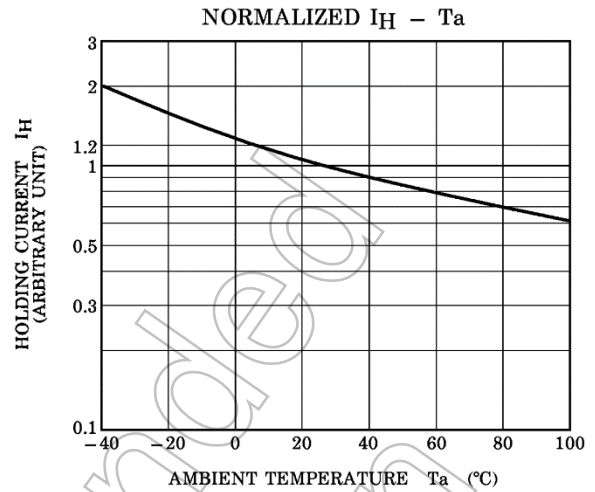
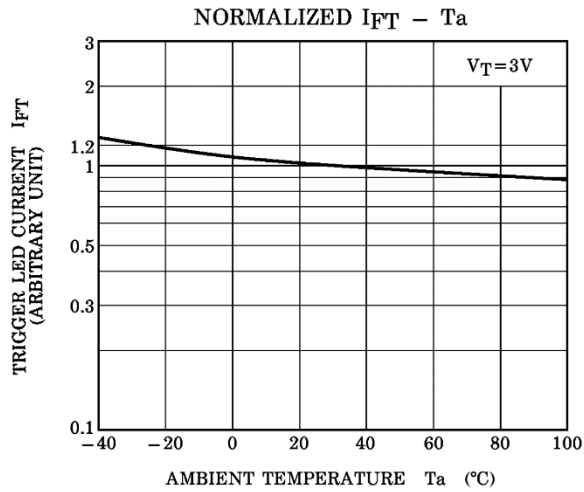
Characteristic	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Trigger LED current	$I_{FT}$	$V_T = 3\text{ V}$	—	5	10	mA
Capacitance input to output	$C_S$	$V_S = 0\text{ V}, f = 1\text{ MHz}$	—	0.8	—	pF
Isolation resistance	$R_S$	$V_S = 500\text{ V}, \text{R.H.} \leq 60\%$	$5 \times 10^{10}$	$10^{14}$	—	$\Omega$
Isolation voltage	$BV_S$	AC, 60 s	2500	—	—	V <sub>rms</sub>

Fig.1 dv / dt Test Circuit





NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



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